

PS710CL2-1A

4-PIN DIP, 0.1 Ω LOW ON-STATE RESISTANCE 2.0 A CONTINUOUS LOAD CURRENT 1-ch Optical Coupled MOS FET

-NEPOC Series-

DESCRIPTION

The PS710CL2-1A is a solid state relay containing a GaAs LED on the input side and MOS FETs on the output side.

It is suitable for PLC, etc. because of its large continuous load current and low on-state resistance. The PS710CL2-1A has a surface mount type with 10.16 mm lead pitch.

FEATURES

- Low on-state resistance ($R_{on} = 0.1 \Omega \text{ TYP.}$)
- Large continuous load current (I_L = 2.0 A)
- 1 channel type (1 a output)
- Low LED operating current (IF = 2 mA)
- · Designed for AC/DC switching line changer
- Small package (4-pin DIP)
- · Low offset voltage
- Ordering number of taping product: PS710CL2-1A-E3, E4: 1 000 pcs/reel

<R> • PI

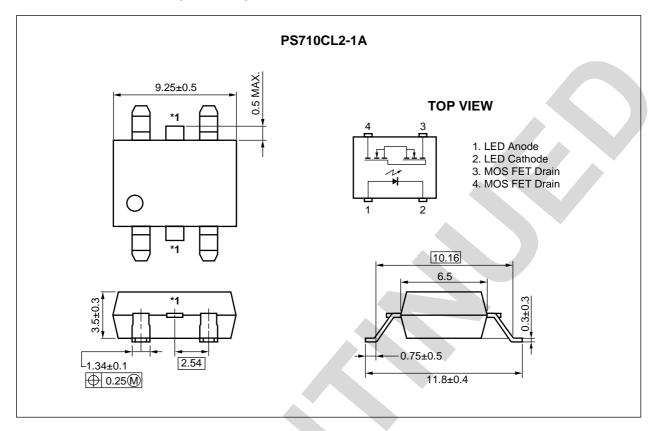
Pb-Free product

APPLICATIONS

- · Measurement equipment
- FA equipment

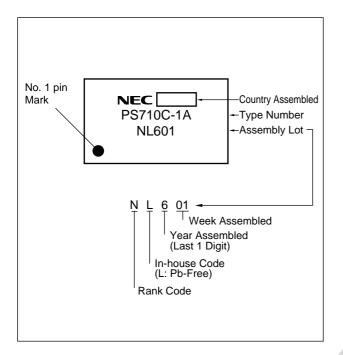
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PACKAGE DIMENSIONS (UNIT: mm)



*1 Cut the lead

<R> MARKING EXAMPLE



<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style
PS710CL2-1A	PS710CL2-1A-A	Pb-Free	Magazine case 50 pcs
PS710CL2-1A-E3	PS710CL2-1A-E3-A		Embossed Tape 1 000 pcs/reel
PS710CL2-1A-E4	PS710CL2-1A-E4-A		

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter			Symbol	Ratings	Unit
Diode	Forward Current (DC)		lF	50	mA
	Reverse Voltage		VR	5.0	V
	Power Dissipation		Po	50	mW
	Peak Forward Current ^{*1}		IFP	1	Α
MOS FET	FET Load Voltage		VL	60	V
	Continuous	Connection A	Iι	2.0	Α
	Load Current *2				
	Pulse Load Current *3 (AC/DC Connection)		ILP	4.0	А
Power Dissipation			Po	600	mW
Isolation Voltage*4		BV	1 500	Vr.m.s.	
Total Power Dissipation			PT	650	mW
Operating Ambient Temperature			TA	-40 to +85	°C
Storage Temperature			T _{stg}	-40 to +100	°C

^{*1} PW = 100 μ s, Duty Cycle = 1%

^{*2} Conditions: IF \geq 2 mA. The following types of load connections are available.



- *3 PW = 100 ms, 1 shot
- *4 AC voltage for 1 minute at $T_A = 25^{\circ}C$, RH = 60% between input and output Pins 1-2 shorted together, 3-4 shorted together.

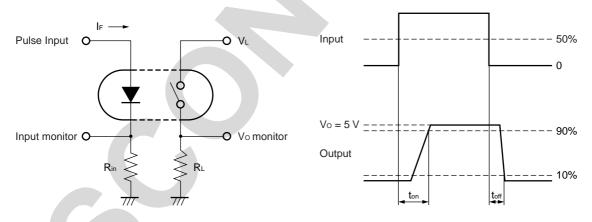
RECOMMENDED OPERATING CONDITIONS (TA = 25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

ELECTRICAL CHARACTERISTICS (TA = 25°C)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	lR	V _R = 5 V			5.0	μА
MOS FET	Off-state Leakage Current	Loff	V _D = 60 V			1.0	μА
	Output Capacitance	Cout	V _D = 0 V, f = 1 MHz		320		pF
Coupled	LED On-state Current	IFon	IL = 2.0 A			2.0	mA
	On-state Resistance	Ron	$I_F = 10 \text{ mA}, I_L = 2.0 \text{ A}, t \le 10 \text{ ms}$		0.1	0.15	Ω
	Turn-on Time *1, 2	ton	If = 10 mA, Vo = 5 V, $R_L = 500 \Omega$,		1.0	3.0	ms
	Turn-off Time *1, 2	t off	PW ≥ 10 ms		0.05	1.0	
	Isolation Resistance	R _{I-O}	Vi-o = 1.0 kVpc	10 ⁹			Ω
	Isolation Capacitance	С-о	V = 0 V, f = 1 MHz		0.5		pF

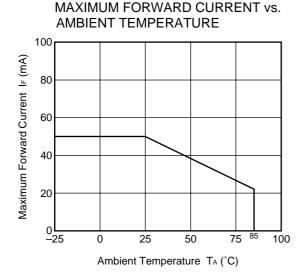
*1 Test Circuit for Switching Time



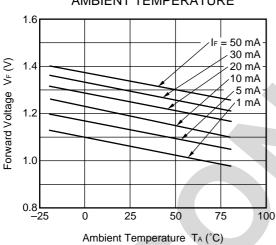
*2 The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms.

Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

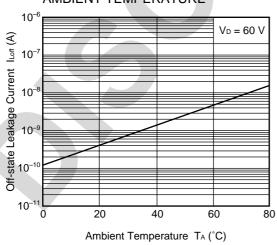
TYPICAL CHARACTERISTICS (Ta = 25°C, unless otherwise specified)





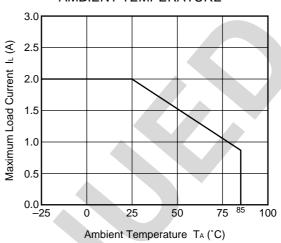


OFF-STATE LEAKAGE CURRENT vs. AMBIENT TEMPERATURE

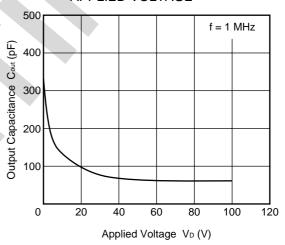


Remark The graphs indicate nominal characteristics.

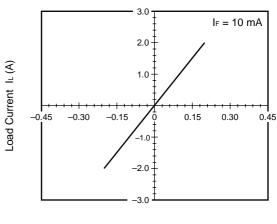




OUTPUT CAPACITANCE vs. APPLIED VOLTAGE

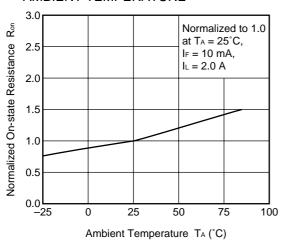


LOAD CURRENT vs. LOAD VOLTAGE

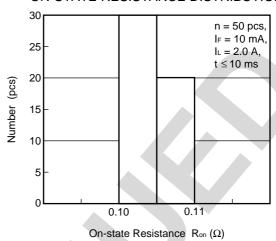


Load Voltage V_L (V)

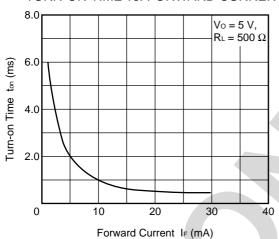
NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



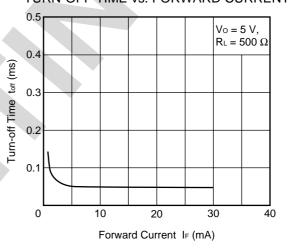
ON-STATE RESISTANCE DISTRIBUTION



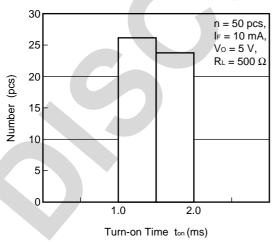
TURN-ON TIME vs. FORWARD CURRENT



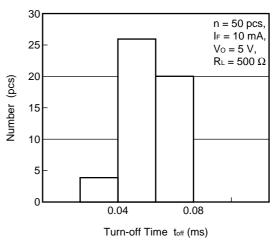
TURN-OFF TIME vs. FORWARD CURRENT



TURN-ON TIME DISTRIBUTION

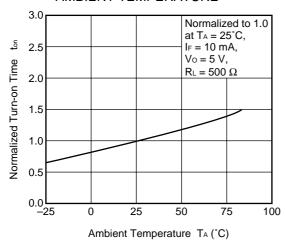


TURN-OFF TIME DISTRIBUTION



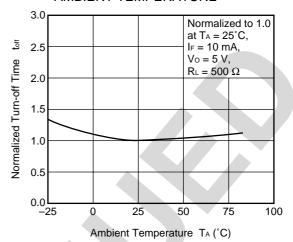
Remark The graphs indicate nominal characteristics.

NORMALIZED TURN-ON TIME vs. AMBIENT TEMPERATURE

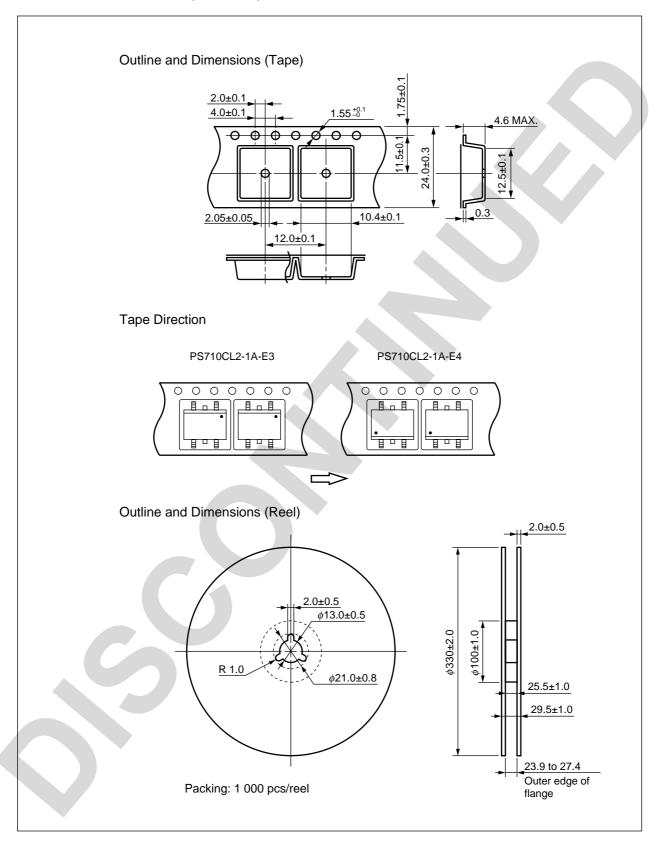


Remark The graphs indicate nominal characteristics.

NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE



TAPING SPECIFICATIONS (UNIT: mm)



RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering

Peak reflow temperature
 260°C or below (package surface temperature)

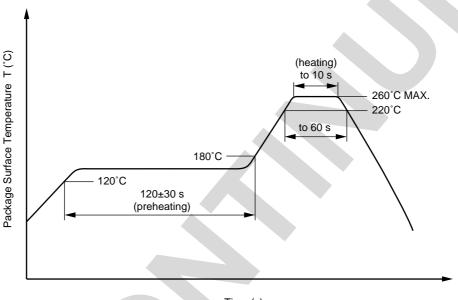
Time of peak reflow temperature
 Time of temperature higher than 220°C
 10 seconds or less
 60 seconds or less

Time to preheat temperature from 120 to 180°C 120±30 s
 Number of reflows Three

Flux
 Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

Preheating conditions
 120°C or below (package surface temperature)

Number of times
 One

Flux
 Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

<R> (3) Soldering by soldering iron

Peak temperature (lead part temperature)
 Time (each pins)
 350°C or below
 3 seconds or less

Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

<R> USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.



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M8E 02.11-1

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

▶ For further information, please contact

NEC Compound Semiconductor Devices Hong Kong Limited

E-mail: contact@ncsd-hk.necel.com

Hong Kong Head Office TEL: +852-3107-7303 FAX: +852-3107-7309
Taipei Branch Office TEL: +886-2-8712-0478 FAX: +886-2-2545-3859
Korea Branch Office TEL: +82-2-558-2120 FAX: +82-2-558-5209

NEC Electronics (Europe) GmbH http://www.eu.necel.com/

TEL: +49-211-6503-0 FAX: +49-211-6503-1327

California Eastern Laboratories, Inc. http://www.cel.com/

TEL: +1-408-988-3500 FAX: +1-408-988-0279

Compound Semiconductor Devices Division NEC Electronics Corporation URL: http://www.ncsd.necel.com/